



MULTI MICRO HORNET

ORG1510-MK04

GPS / GNSS MODULE WITH INTEGRATED ANTENNA

Datasheet

OriginGPS.com



INDEX

1.	SCOPE	5
2.	DISCLAIMER	5
3.	SAFETY INFORMATION	5
4.	ESD SENSITIVITY	5
5.	CONTACT INFORMATION	5
6.	RELATED DOCUMENTATION	5
7.	REVISION HISTORY	5
8.	GLOSSARY	6
9.	ABOUT HORNET FAMILY	9
10.	ABOUT Multi Micro Hornet MODULE	9
11.	ABOUT ORIGINGPS	9
12.	DESCRIPTION	10
12.1.	FEATURES.....	10
12.2.	ARCITECTURE	11
12.3.	ORG1510-MK04 FEATURES DESCRIPTIO:	13
12.3.2.	1PPS.....	13
12.3.3.	STATIC NAVIGATIN.....	13
12.3.4.	ASSISTED GPS (AGPS).....	13
12.3.4.1.	LOCALLY-GENERETED AGPS (EMBEDDED ASSIST SYSTEM - EASY).....	14
12.3.4.2.	SERVER-GENERATED AGPS (EXTENDED PREDICTION - EPO).....	14
12.3.4.3.	HOTSTILL (EXTENDED PREDICTION ORBIT).....	14
12.3.5.	QUASI - ZENITH SATELLITE (QZSS).....	15
12.3.6.	SATELLITE - BASED AUGMENTATION SYSTEM (SBAS).....	15
12.3.7.	DIFFERENT GPS (DGPS).....	15
12.3.8.	JAMMING REJECTION - ACTIVE INTERFERENCE CANCELLATION (AIC)	15
12.3.9.	POWER MANAGEMENT MODES.....	15
12.3.9.1.	FULL POWER CONTINUOUS MODE.....	16
12.3.9.2.	STANDBY MODE.....	16
12.3.9.3.	PERIODIC MODE.....	16
12.3.9.4.	ALWAYSLOCATE MODE.....	17
12.4.	PAD ASSIGNMENT.....	18
13.	MECHANICAL SPECIFICATIONS.....	19
14.	ELECTRICAL SPECIFICATIONS	20
14.1.	ABSOLUTE MAXIMUM RATINGS	20
14.2.	RECOMMENDE OPERATING CONDITIONS.....	21
15.	PERFORMANCE	22
15.1.	ACQUISITION TIME	22
15.1.1.	HOT START	22
15.1.2.	SIGNAL REACQUISITION.....	22
15.1.3.	AIDED START	22
15.1.4.	WARM START.....	22
15.1.5.	COLD START	22
15.2.	SENSITIVITY	23
15.2.1.	TRACKING	23
15.2.2.	REACQUISITION	23
15.2.3.	NAVIGATION	23
15.2.4.	HOT START	23
15.2.5.	AIDED START	23
15.2.6.	COLD START	23
15.3.	RECEIVED SIGNAL STRENGTH	24
15.4.	POWER CONSUMPTION.....	24
15.5.	ACCURACY	25
15.6.	DYNAMIC CONSTRAINS.....	25
16.	INTERFACE	26
16.1	POWER SUPPLY.....	26



16.1.1	NOMINAL VCC = 3.3V.....	26
16.1.2	GROUND	26
16.2.	CONTROL INTERFACE.....	26
16.2.1.	UART - HOST INTERFACE.....	26
16.2.1.1.	TX.....	26
16.2.1.2.	RX.....	26
16.2.1.3.	CTS.....	26
16.2.2.	DATA INTERDACE.....	26
16.2.2.1	FORCE - ON.....	26
16.2.2.2.	RESET	27
16.2.2.3.	1PPS	27
17.	TYPICAL APPLICATION CIRCUIT.....	28
18.	RECOMMENDED PCB LAYOUT	28
18.1.	FOOTPRINT	28
18.2.	HOST PCB	29
18.3.	PCB STACK-UP.....	30
18.4.	PCB LAYOUT RESTRICTIONS	30
19.	DESIGN CONSIDERATIONS	30
20.	COMMANDS DESCRIPTION.....	31
21.	FIRMWARE UPDATES.....	31
22.	HANDLING INFORMATION.....	31
22.1.	MOISTURE SENSITIVITY.....	32
22.2.	ASSEMBLY	32
22.3.	SOLDERING	32
22.4.	CLEANING	33
22.5.	REWORK.....	33
22.6.	ESD SENSITIVITY.....	33
22.7.	SAFETY INFORMATION	33
22.8.	DISPOSAL INFORMATION	33
23.	COMPLIANCE	34
24.	PACKAGING AND DELIVERY	34
24.1.	APPEARANCE	34
24.2.	CARRIER TAPE	35
24.3.	REEL	36
25.	ORDERING INFORMATION.....	36

DRAFT



TABLE INDEX

TABLE 1 – RELATED DOCUMENTATION	5
TABLE 2 – REVISION HISTORY	5
TABLE 3 – PIN-OUT.....	18
TABLE 4 – MECHANICAL SUMMARY	19
TABLE 5 – ABSOLUTE MAXIMUM RATINGS	20
TABLE 6 – RECOMMENDED OPERATING CONDITIONS	21
TABLE 7 – ACQUISITION TIME.....	22
TABLE 8 – SENSITIVITY	23
TABLE 9 – RECEIVED SIGNAL STRENGTH.....	24
TABLE 10 – POWER CONSUMPTION	24
TABLE 11 – POSITION ACCURACY	25
TABLE 12 – DYNAMIC CONSTRAINS.....	25
TABLE 13 – NMEA INPUT COMMANDS.....	31
TABLE 14 – SOLDERING PROFILE PARAMETERS.....	33
TABLE 15 – REEL QUANTITY	34
TABLE 16 – CARRIER TAPE DIMENSIONS	35
TABLE 17 – REEL DIMENSIONS.....	36
TABLE 18 – ORDERABLE DEVICES.....	36

FIGURE INDEX

FIGURE 1 – ORG1510-MK04 ARCHITECTURE	11
FIGURE 2 – MT3333 SYSTEM BLOCK DIAGRAM.....	12
FIGURE 3 – EASY TIMING	14
FIGURE 4 – PERIODIC POWER SAVING MODE	16
FIGURE 5 – ALWAYSLOCATE MODE	17
FIGURE 6 – PADS ASSIGNMENT	18
FIGURE 7 – MECHANICAL DRAWING	19
FIGURE 8 – 1PPS AND UTC TIMING.....	27
FIGURE 9 – REFERENCE SCHEMATIC DIAGRAM	28
FIGURE 10 – FOOTPRINT	28
FIGURE 11 – MODULE HOSTED ON FOOTPRINT	29
FIGURE 12 – HOST PCB	29
FIGURE 13 – EVB GROUND PLANE VIAS (TOP).....	29
FIGURE 14 – EVB GROUND PLANE VIAS (BOTTOM).....	29
FIGURE 15 – TYPICAL PCB STACK-UP	30
FIGURE 16 – RECOMMENDED SOLDERING PROFILE.....	32
FIGURE 17 – MODULE POSITION	34
FIGURE 18 – CARRIER TAPE.....	35
FIGURE 19 – REEL.....	36
FIGURE 20 - ORDERING OPTIONS.....	36



1. SCOPE

This document describes the features and specifications of Multi Micro Hornet ORG1510-MK04 GNSS receiver module with integrated antenna.

2. DISCLAIMER

All trademarks are properties of their respective owners.

Performance characteristics listed in this document do not constitute a warranty or guarantee of product performance. OriginGPS assumes no liability or responsibility for any claims or damages arising out of the use of this document, or from the use of integrated circuits based on this document.

OriginGPS assumes no liability or responsibility for unintentional inaccuracies or omissions in this document. OriginGPS reserves the right to make changes in its products, specifications and other information at any time without notice.

OriginGPS reserves the right to conduct, from time to time, and at its sole discretion, firmware upgrades. As long as those FW improvements have no material change on end customers, PCN may not be issued. OriginGPS navigation products are not recommended to use in life saving or life sustaining applications.

3. SAFETY INFORMATION

Improper handling and use can cause permanent damage to the product.

4. ESD SENSITIVITY

This product is ESD sensitive device and must be handled with care.



5. CONTACT INFORMATION

Support - support@origingps.com or [Online Form](#)

Marketing and sales - marketing@origingps.com

Web – www.origingps.com

6. RELATED DOCUMENTATION

No	DOCUMENT NAME
1	Multi Micro Hornet – ORG1510-MK04 Evaluation Kit Datasheet
2	Spider and Hornet - Software User Manual
3	Spider and Hornet - NMEA Protocol Reference Manual

TABLE 1 – RELATED DOCUMENTATION

7. REVISION HISTORY

REVISION	DATE	CHANGE DESCRIPTION	Author
1.0	October 15, 2015	First release	Ori Adas

TABLE 2 – REVISION HISTORY

8. GLOSSARY

A-GPS Assisted **GPS**
ABP™ Almanac **B**ased **P**osition
AC Alternating **C**urrent
ADC Analog to **D**igital **C**onverter
AGC Automatic **G**ain **C**ontrol
APM™ Adaptive **P**ower **M**anagement
ATP™ Adaptive **T**rickle **P**ower
BBRAM Battery **B**acked-up **R**AM
BE Broadcast **E**phemeris
BPF Band **P**ass **F**ilter
C/N₀ Carrier to **N**oise density ratio [dB-Hz]
CDM Charged **D**evice **M**odel
CE European Community conformity mark
CEP Circular **E**rror **P**robability
CGEE™ Client **G**enerated **E**xtended **E**phemeris
CMOS Complementary **M**etal-**O**xide **S**emiconductor
CPU Central **P**rocessing **U**nit
CTS Clear-**T**o-**S**end
CW Continuous **W**ave
DC Direct **C**urrent
DOP Dilution **O**f **P**recision
DR Dead **R**eckoning
DSP Digital **S**ignal **P**rocessor
ECEF Earth **C**entred **E**arth **F**ixed
ECHA European **C**hemical **A**gency
EE Extended **E**phemeris
EGNOS European **G**eostationary **N**avigation **O**verlay **S**ervice
EIA Electronic **I**ndustries **A**lliance
EMC Electro-**M**agnetic **C**ompatibility
EMI Electro-**M**agnetic **I**nterference
ENIG Electroless **N**ickel **I**mmersion **G**old
ESD Electro-**S**tatic **D**ischarge
ESR Equivalent **S**eries **R**esistance
EU European **U**ion
EVB Evaluation **B**oard
EVK Evaluation **K**it
FCC Federal **C**ommunications **C**ommission
FSM Finite **S**tate **M**achine
GAGAN **G**PS **A**ided **G**eo-**A**ugmented **N**avigation
GNSS Global **N**avigation **S**atellite **S**ystem
GPIO General **P**urpose **I**nput or **O**utput
GPS Global **P**ositioning **S**ystem
HBM Human **B**ody **M**odel
HDOP Horizontal **D**ilution **O**f **P**recision
I²C Inter-**I**ntegrated **C**ircuit
I/O Input or **O**utput
IC Integrated **C**ircuit
ICD Interface **C**ontrol **D**ocument
IF Intermediate **F**requency
ISO International **O**rganization for **S**tandardization

JEDEC Joint Electron Device Engineering Council
KA Keep Alive
KF Kalman Filter
LDO Low Dropout regulator
LGA Land Grid Array
LNA Low Noise Amplifier
LP Low Power
LS Least Squares
LSB Least Significant Bit
MID Message Identifier
MM Machine Model
MPM™ Micro Power Mode
MSAS Multi-functional Satellite Augmentation System
MSB Most Significant Bit
MSL Moisture Sensitivity Level
NFZ™ Noise-Free Zones System
NMEA National Marine Electronics Association
NVM Non-Volatile Memory
OSP® One Socket Protocol
PCB Printed Circuit Board
PLL Phase Lock Loop
PMU Power Management Unit
POR Power-On Reset
PPS Pulse Per Second
PRN Pseudo-Random Noise
PSRR Power Supply Rejection Ratio
PTF™ Push-To-Fix
QZSS Quasi-Zenith Satellite System
RAM Random Access Memory
REACH Registration, Evaluation, Authorisation and Restriction of Chemical substances
RF Radio Frequency
RHCP Right-Hand Circular Polarized
RMS Root Mean Square
RoHS Restriction of Hazardous Substances directive
ROM Read-Only Memory
RTC Real-Time Clock
RTS Ready-To-Send
SAW Surface Acoustic Wave
SBAS Satellite-Based Augmentation Systems
SGEE™ Server Generated Extended Ephemeris
SID Sub-Identifier
SIP System In Package
SMD Surface Mounted Device
SMPS Switched Mode Power Supply
SMT Surface-Mount Technology
SOC System On Chip
SPI Serial Peripheral Interface
SSB® SiRF Standard Binary
SV Satellite Vehicle
TCXO Temperature-Compensated Crystal Oscillator
TTF Time To First Fix



TTL Transistor-Transistor Logic

UART Universal Asynchronous Receiver/Transmitter

VCCI Voluntary Control Council for Interference by information technology equipment

VEP Vertical Error Probability

VGA Variable-Gain Amplifier

WAAS Wide Area Augmentation System

DRAFT

9. ABOUT HORNET FAMILY

OriginGPS GNSS receiver modules have been designed to address markets where size, weight, stand-alone operation, highest level of integration, power consumption and design flexibility - all are very important.

OriginGPS' Hornet family breaks size barrier, offering the industry's smallest fully-integrated, highly-sensitive GPS and GNSS modules with integrated antennas or on-board RF connectors.

Hornet family features OriginGPS' proprietary NFZ™ technology for high sensitivity and noise immunity even under marginal signal condition, commonly found in urban canyons, under dense foliage or when the receiver's position in space rapidly changes.

Hornet family enables the shortest TTM (Time-To-Market) with minimal design risks.

Just connect power supply on a single layer PCB.

10. ABOUT MULTI MICRO HORNET MODULE

Micro Hornet is a complete SiP featuring miniature LGA SMT footprint designed to commit unique integration features for high volume cost sensitive applications.

Designed to support compact and traditional applications such as smart watches, wearable devices, asset trackers, Multi Micro Hornet ORG1510MK-04 module is a miniature multi-channel GPS and GLONASS/BEIDOU, SBAS, QZSS overlay systems receiver that continuously tracks all satellites in view, providing real-time positioning data in industry's standard NMEA format.

Multi Micro Hornet ORG1510 module offers superior sensitivity and outstanding performance, achieving rapid TTFF in less than one second, accuracy of approximately two meters, and tracking sensitivity of -165dBm.

Sized only 10mm x 10mm Multi Micro Hornet ORG1510 module is industry's small sized, record breaking solution.

Multi Micro Hornet ORG1510 module is introducing industry's lowest energy per fix ratio, unparalleled accuracy and extremely fast fixes even under challenging signal conditions, such as in built-up urban areas, dense foliage or even indoor.

Integrated GPS SoC incorporating high-performance microprocessor and sophisticated firmware keeps positioning payload off the host, allowing integration in embedded solutions with low computing resources.

Innovative architecture can detect changes in context, temperature, and satellite signals to achieve a state of near continuous availability by maintaining and opportunistically updating its internal fine time, frequency, and satellite ephemeris data while consuming mere microwatts of battery power.

11. ABOUT ORIGINGPS

OriginGPS is a world leading designer, manufacturer and supplier of miniature positioning modules, antenna modules and antenna solutions.

System (NFZ™) proprietary technology for faster position fix and navigation stability even under challenging satellite signal conditions.

Founded in 2006, OriginGPS is specializing in development of unique technologies that miniaturize RF modules, thereby addressing the market need for smaller wireless solutions.

12. DESCRIPTION

12.1. FEATURES

- + Autonomous operation
- + Active antenna on-board
- + Pin to pin compatible with all ORG1410/ORG1411 GPS and ORG1510-R01 GNSS modules
- + OriginGPS Noise Free Zone System (NFZ™) technology
- + Fully integrating:
Antenna element, Dual-stage LNA, SAW filter, TCXO, RTC crystal, GNSS SoC, LDO regulator, RF shield
- + Concurrent tracking of multiple constellations
- + Uses GPS and GLONASS/BEIDOU, QZSS constellations.
- + GPS L1 1575.42 frequency, C/A code
- + GLONASS L1 FDMA 1598-1606MHz frequency band, SP signal
- + BEIDOU B1 1561.098MHz frequency band.
- + SBAS (WAAS, EGNOS, MSAS and GAGAN)
- + DGPS capability (using RTCM)
- + 99 search channels and 33 simultaneous tracking channels
- + Ultra-high Sensitivity down to -165dBm enabling Indoor Tracking
- + TTFF of < 1s in 50% of trials under Hot Start conditions
- + Low Power Consumption of $\leq 15\text{mW}$
- + High Accuracy of < 2.5m in 50% of trials
- + AGPS support: Embedded Assist System (EASY) and Extended Prediction Orbit (EPO) and HotStill
- + Indoor and outdoor Multipath and cross-correlation mitigation
- + Jamming Rejection – 12 multi-tone Active Interference Cancellation (AIC)
- + 8 Megabit built in flash
- + Power management modes: Full Power Continuous, Standby, Periodic and AlwaysLocate™
- + NMEA commands and data output over UART serial interface
- + High update messages rate of 1,2,5,10Hz
- + 1PPS Output
- + Static Navigation
- + Single voltage supply 2.8V to 4.3V
- + Ultra-small LGA footprint of 10mm x 10mm
- + Ultra-low weight of 2.4g
- + Surface Mount Device (SMD)
- + Optimized for automatic assembly and reflow equipment
- + Operating from -40°C to +85°C
- + FCC, CE, VCCI compliant
- + RoHS II/REACH compliant

12.2. ARCHITECTURE

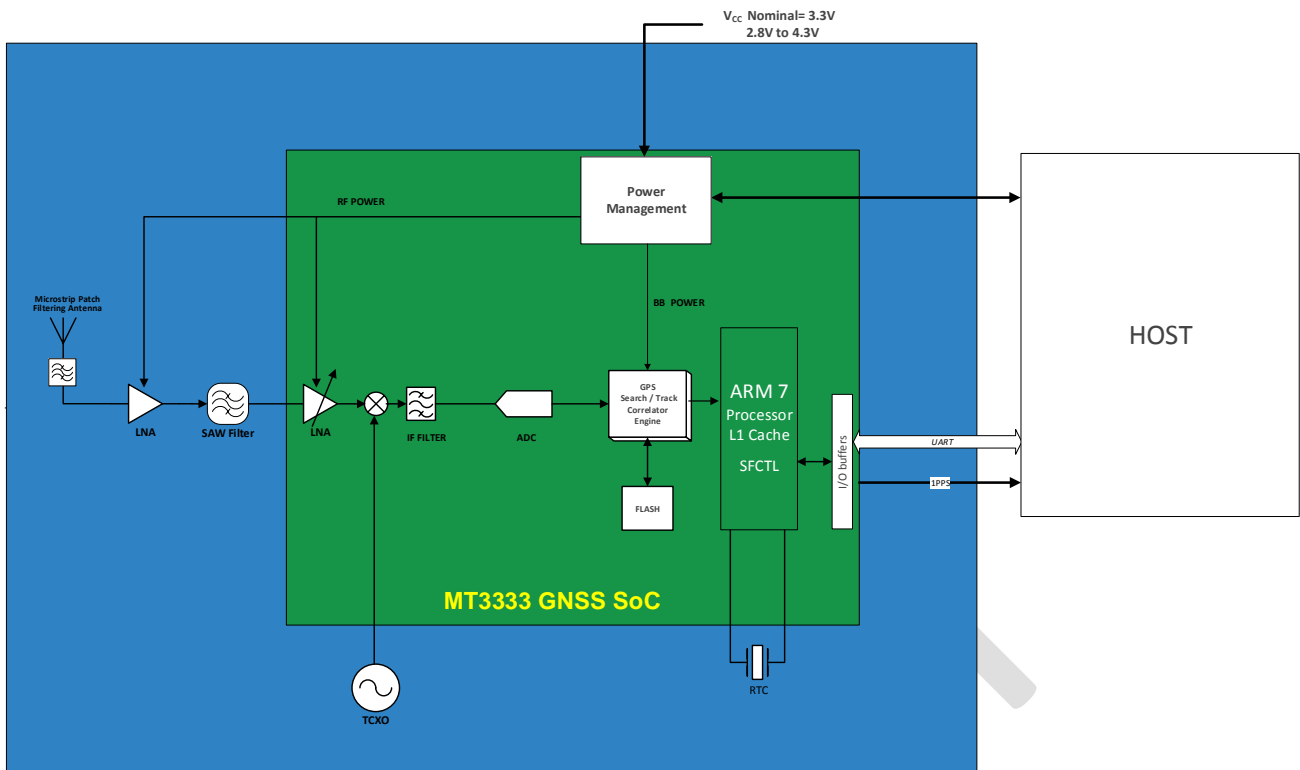


FIGURE 1 – ORG1510-MK04 ARCHITECTURE

+ Antenna

OriginGPS proprietary Microstrip Patch Antenna collects GNSS signals from the medium. Antenna is built from hi-K ceramic element mounted on top of RF shield, providing stable resonance.

+ GNSS SAW Filter

Band-Pass SAW filter eliminates out-of-band signals that may interfere to GNSS reception. GNSS SAW filter is optimized for low Insertion Loss in GNSS band and low Return Loss outside it.

+ GNSS LNA

Dual-stage cascaded LNAs amplify GNSS signals to meet RF down converter input threshold. Noise Figure optimized design was implemented to provide maximum sensitivity.

+ TCXO

Highly stable 26MHz oscillator controls down conversion process in RF block of the GNSS SoC. Characteristics of this component are important factors for higher sensitivity, shorter TTFF and better navigation stability.

+ RTC crystal

RTC 32.768 KHz quartz crystal with very tight specifications is necessary for maintaining Hot Start and Warm Start capabilities of the module.

+ LDO regulator (optional)

RF LDO provides regulated voltage supply over wide input voltage range, with low quiescent current and high PSRR.

+ RF Shield

RF enclosure avoids external interference from compromising sensitive circuitry inside the module. RF shield also blocks module's internal high frequency emissions from being radiated.

+ MT3333 GNSS SoC

The MT3333, multi-GNSS System on Chip designed by MediaTek, which is the world's leading digital media solution provider and largest fab-less IC Company in Taiwan.

It is a hybrid positioning processor that combines GPS, GLONASS, GALILEO, BEIDOU, SBAS, QZSS, DGPS and AGPS to provide a high performance navigation solution.

MT3333 is a full SoC built on a low-power RF CMOS, incorporating GNSS RF, GNSS baseband, integrated navigation solution software, ARM® processor and serial flash.

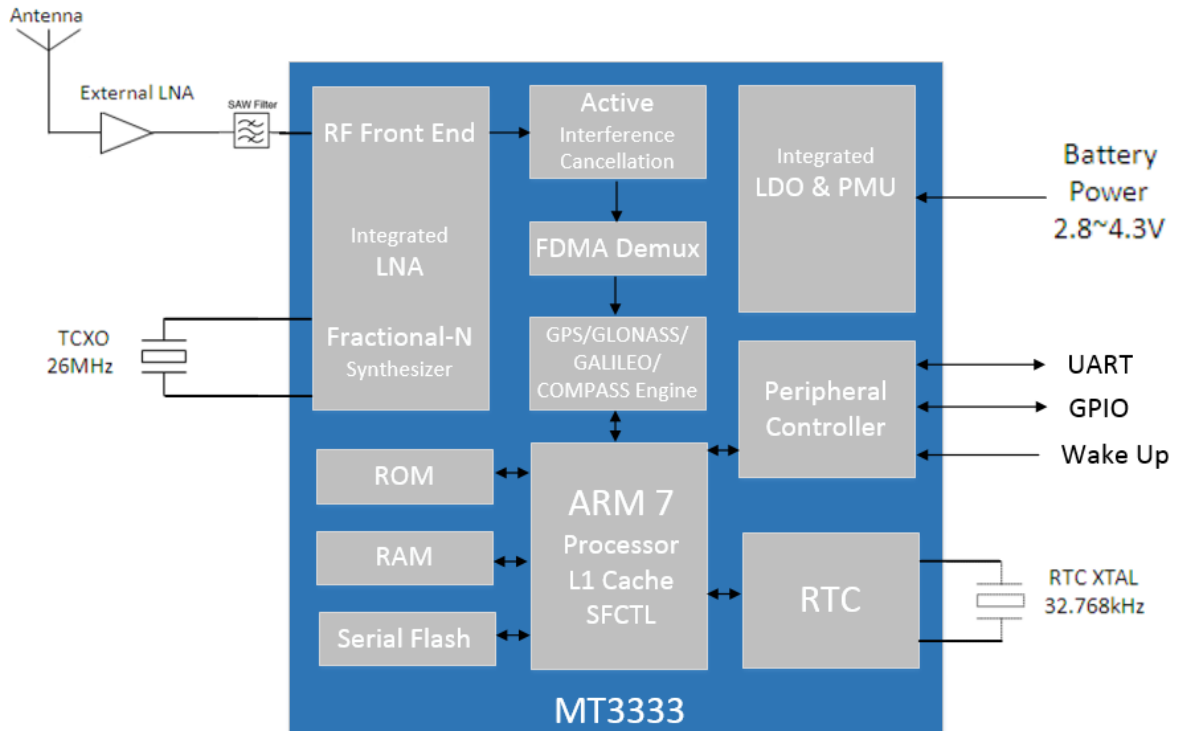


FIGURE 2 – MT3333 SYSTEM BLOCK DIAGRAM AND PERIPHERAL

MT3333 SoC includes the following units:

- + GNSS radio subsystem containing single input dual receive paths for concurrent GPS and GLONASS or GPS and BEIDO, mixer with current mode interface between the mixer and multi-modes low pass filter, fractional-N synthesizer, integrated self-calibrating filters, IF VGA with AGC, high-sample rate ADCs with adaptive dynamic range.
- + Measurement subsystem including DSP core for GNSS signals acquisition and tracking, interference scanner and detector, interference removers, multipath and cross-correlation detectors, dedicated DSP code ROM and DSP cache RAM.
- + Measurement subsystem interfaces GNSS radio subsystem.
- + Navigation subsystem comprising ARM7® microprocessor system for position, velocity and time solution, program ROM, data RAM, cache and patch RAM and SPI flash.
- + Peripheral Controller subsystem containing UART Host interface, RTC block, wake up signal option, and GPIO.
- + Peripheral Controller subsystem interfaces navigation subsystem, PLL and PMU subsystems.
- + Navigation subsystem interfaces measurement subsystem.
- + PMU subsystem containing voltage regulators for RF and baseband domains.

12.3. ORG1510-MK04 FEATURES DESCRIPTION:

12.3.2 1PPS

1PPS (Pulse Per Second) signal output available on configuration:

- At 2D Fix only.
- At 3D Fix only.
- After the first Fix
- Always.

The pulse is configurable for required duration, frequency and active high/low via command.

The pulse may vary 30nS (1σ). The relationship between the PPS signal and UTC is unspecified.

12.3.3 Static Navigation

Static Navigation is an operational mode in which the receiver will freeze the position fix when the speed falls below a threshold (indicating that the receiver is stationary). The course is also frozen, and the speed is reported as 0. The navigation solution is then unfrozen when the speed increases above a threshold or when the computed position exceeds a set distance from the frozen position (indicating that the receiver is again in motion). The speed threshold can be set via a command. Static Navigation is disabled by default, but can be enabled by command. This feature is useful for applications in which very low dynamics are not expected, the classic example being an automotive application.

12.3.4 Assisted GPS (AGPS)

Assisted GPS (or Aided GPS) is a method by which TTFF is reduced using information from a source other than broadcast GPS signals. The necessary ephemeris data is calculated either by the receiver itself (locally-generated ephemeris) or a server (server-generated ephemeris) and stored in the module.

ORG1510-MK04 has EASY, EPO and HotStill technology to allow for Hot Starts even in weak signal conditions and moving start-ups. EPO (Extended Prediction Orbit) is one of MediaTek's innovative proprietary off-line server based AGPS solution. Host could use an application to store and load the EPO files into device. With multi-constellation EPO, the user experience will be enhanced by the improved Time To First Fix (TTFF) and better first fix accuracy.

12.3.4.1 Locally-generated AGPS (Embedded Assist System – EASY)

The EASY™ is embedded assist system for quick positioning, the GPS engine will calculate and predict automatically the single ephemeris (Max. up to 3 days) when power on, and save the predict information into the memory, GPS engine will use these information for positioning if no enough information from satellites, so the function will be helpful for positioning and TTFF improvement under indoor or urban condition, the Backup power (VBACKUP) is necessary.

Up to 3 days extension for single received ephemeris:

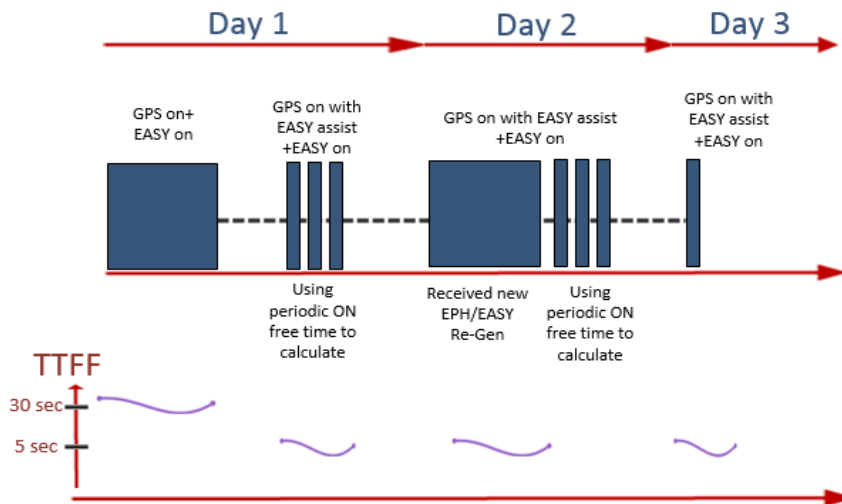


FIGURE 3 – EASY™ TTFF TIMING

12.3.3.2 Server-generated AGPS (Extended Prediction Orbit – EPO)

The AGPS (EPO™) supply the predicated Extended Prediction Orbit data to speed TTFF ,users can download the EPO data to GNSS engine from the FTP server by internet or wireless network ,the GNSS engine will use the EPO data to assist position calculation when the navigation information of satellites are not enough or weak signal zone .

Host could use an application to store and load the EPO files into device. With multi-Constellation EPO, the user experience will be enhanced by the improved Time To First Fix (TTFF) and better first fix accuracy.

The predicted ephemeris file is obtained from the AGPS server and is injected into the module over serial port 1 (RX1). These predictions do not require local broadcast ephemeris collection, and they are valid for up to 14 days.

12.3.3.3 HotStill (Extended Prediction Orbit)

HotStill is one of MTK’s innovative proprietary Off-line client based A-GPS solution which could greatly accelerate GPS TTFF (Time to First Fix) in urban canyon or weak signal environment from several minutes to only few seconds. It works as a background software running on the host processor to predicate satellite orbit navigation data and generate Broadcast Ephemeris Extension (BEE) from received broadcast ephemeris as well as no network connection requirements.

12.3.4 Quasi-Zenith Satellite System (QZSS)

The three satellites of the Japanese SBAS are in a highly-inclined elliptical orbit which is geosynchronous (not geostationary) and has analemma-like ground tracks. This orbit allows continuous coverage over Japan using only three satellites. Their primary purpose is to provide augmentation to the GPS system, but the signals may also be used for ranging. NMEA reporting for QZSS may be enabled/disabled by the user.

12.3.5 Satellite-Based Augmentation System (SBAS)

The SE868-A/AS receiver is capable of using Satellite-Based Augmentation System (SBAS) satellites as a source of both differential corrections and satellite range measurements. These systems (WAAS, EGNOS, MSAS, and GAGAN) use geostationary satellites to transmit regional differential corrections via a GNSS-compatible signal. The use of SBAS corrections can significantly improve position accuracy, and is enabled by default.

12.3.6 Differential GPS (DGPS)

DGPS is a Ground-Based Augmentation System (GBAS) for reducing position errors by applying corrections from a set of accurately-surveyed ground stations located over a wide area. These reference stations measure the range to each satellite and compare it to the known-good range. The differences can then be used to compute a set of corrections which are transmitted to a DGPS receiver, either by radio or over the internet. The DGPS receiver can then send them to the serial port 1 (RX1) using the RTCM SC-104 message protocol. The corrections can significantly improve the accuracy of the position reported to the user. The receiver can accept and apply either the RTCM SC-104 messages or SBAS differential data.

12.3.7 Jamming Rejection – Active Interference Cancellation (AIC)

The ORG1510-MK04 detect, track and removes narrow-band interfering signals (jamming signals) without the need for external components or tuning. It tracks and removes up to 12 CW (Continuous Wave) type signals up to -80 dBm (total power signal levels). By default, the jamming detection is enabled but can be disabled by command. This feature is useful both in the design stage and during the production stage for uncovering issues related to unexpected jamming. When enabled, AIC will increase current consumption by about 1 mA. Impact on GNSS performance is minimal at low jamming levels, however at high jamming levels (e.g. -90 to -80 dBm), the RF signal sampling ADC starts to become saturated after which the GNSS signal levels start to diminish.

12.3.8 Power Management Modes

The ORG1510-MK04 support operational modes that allow them to provide positioning information at reduced overall current consumption. Availability of GNSS signals in the operating environment will also be a factor in choice of power management modes. The designer can choose a mode that provides the best trade-off of performance versus power consumption.

The power management modes are described below, and can be enabled via command:

- **Full Power Continuous- for best GNSS performance**
- **Power save mode to optimize power consumption:**
 - **Standby**
 - **Periodic**
 - **AlwaysLocate™**
- **Backup state**

12.3.8.1 Full Power Continuous Mode

The modules start up in full power continuous mode. This mode uses the acquisition engine at full performance resulting in the shortest possible TTFF and the highest sensitivity. It searches for all possible satellites. The receiver then switches to the tracking engine to lower the power consumption when:

- A valid GPS/GNSS position is obtained
- The ephemeris for each satellite in view is valid

To return to Full Power mode (from a low power mode), send the following command: **PMTK225,0*2B** [Just after the module wakes up from its previous sleep cycle].

12.3.8.2 Standby Mode

In this mode, the receiver stops navigation, the internal processor enters standby state, and the current drain at main supply (VCC) is reduced. Standby mode is entered by sending the following command: **PMTK161,0*28**

The host can then wake up the module from Standby mode to Full Power mode by sending any byte to the serial port.

12.3.8.3 Periodic Mode

This mode allows autonomous power on/off with reduced fix rate to reduce average power consumption. In periodic mode, the main power supply VCC is still powered, but power distribution to internal circuits is controlled by the receiver.

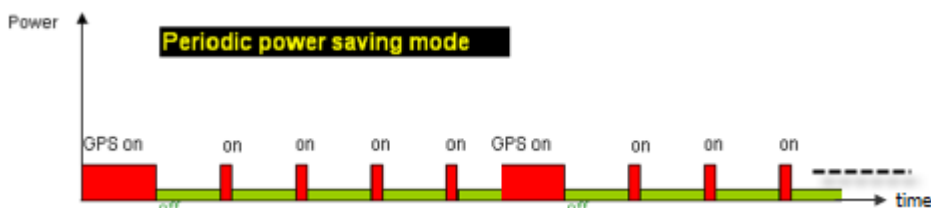


FIGURE 4 – PERIODIC POWER SAVING MODE

Enter periodic mode by sending the following command:

PMTK225,<Type>,<Run_time>,<Sleep_time>,<2nd_run_time>,<2nd_sleep_time>*<checksum>

Where:

- Type = 1 for Periodic mode
- Run_time = Full Power period (ms)
- Sleep_time = Standby period (ms)
- 2nd_run_time = Full Power period (ms) for extended acquisition if GNSS acquisition fails during Run_time.
- 2nd_sleep_time = Standby period (ms) for extended sleep if GNSS acquisition fails during Run_time

Example: **PMTK225,1,3000,12000,18000,72000*16**

for periodic mode with 3 s navigation and 12 s sleep. The acknowledgement response for this command is: **PMTK001,225,3*35**

Periodic mode is exited by sending the command: **PMTK225,0*2B**

just after the module wakes up from a previous sleep cycle.

12.3.8.4 AlwaysLocate™ Mode

AlwaysLocate™ is an intelligent controller of the Periodic mode; the main power supply VCC is still powered up, but power distribution is internally controlled. Depending on the environment and motion conditions, the module can autonomously and adaptively adjust the parameters of the Periodic mode, e.g. ON/OFF ratio and fix rate to achieve a balance in positioning accuracy and power consumption. The average current can vary based on conditions.

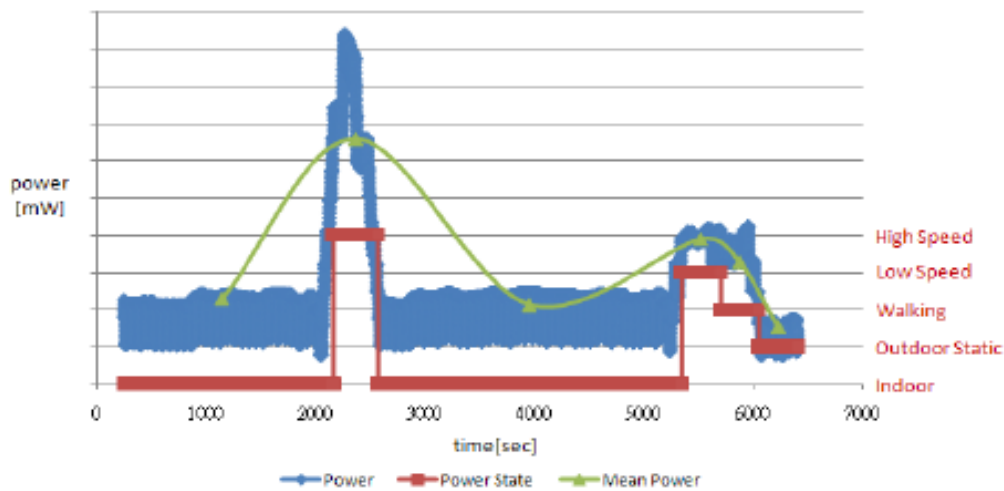


FIGURE 5 – AlwaysLocate™ MODE: POWER VS. TIME

Enter AlwaysLocate™ mode by sending the following NMEA command:

PMTK225,<mode>*<checksum><CR><LF>

Where: mode=9 for AlwaysLocate™

Example:

PMTK225,9*22.

The acknowledgement response for the command is:

PMTK001,225,3*35.

The user can exit low power modes to Full Power by sending NMEA command:

PMTK225,0*2B

Just after the module wakes up from its previous sleep cycle.

12.3.8.5 Backup State

Backup State means a low quiescent power state where receiver operation is stopped; only the backup supply V_BCKP is powered on while the main supply VCC is switched off by the host (or autonomously by ORG1510-MK04 in Periodic mode and AlwaysLocate™ mode). Waking up from Backup State to Full Power is controlled by the host by switching on the VCC supply.

After waking up, the receiver uses all internal aiding, including GNSS time, Ephemeris, and Last Position, resulting in the fastest possible TTFF in either hot or warm start modes.

During Backup State, the I/O block is powered off. The suggestion is that the host forces its outputs to a low state or to a high-Z state during the Backup State to minimize small leakage currents at receiver's input signals.

12.4. PADS ASSIGNMENT

PAD	NAME	FUNCTION	DIRECTION	Logic level
1	FORCE ON	Forced full-power mode signal – Active Low	Input	1.2V
2	1PPS	UTC Time Mark	Output	2.8V
3	TX	UART Transmit (Serial Output)	Output	2.8V
4	Vcc	System Power	Power	3.3V
5	GND	System Ground	Power	
6	GPIO12	GPIO12/ WAKEUP/ EINT0	Input /Output	2.8V
7	CTS	UART Clear To Send	Input	2.8V
8	$\overline{\text{RESET}}$	System Reset– Active Low	Input	2.8V
9	RTS	UART Ready To Send	Output	2.8V
10	RX	UART Receive (Serial Input)	Input	2.8V

TABLE 3 – PIN-OUT

BOTTOM VIEW

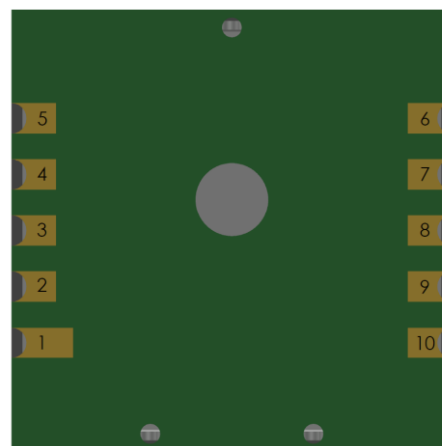


FIGURE 6 – PADS ASSIGNMENT

13. MECHANICAL SPECIFICATIONS

- + ORG1510 module has advanced ultra-miniature LGA SMD packaging sized 10mm x 10mm.
- + ORG1510 built on a PCB assembly enclosed with metallic RF shield box and antenna element on top of it.
- + There are 10 castellated LGA SMT pads made Cu base and ENIG plating on bottom side.

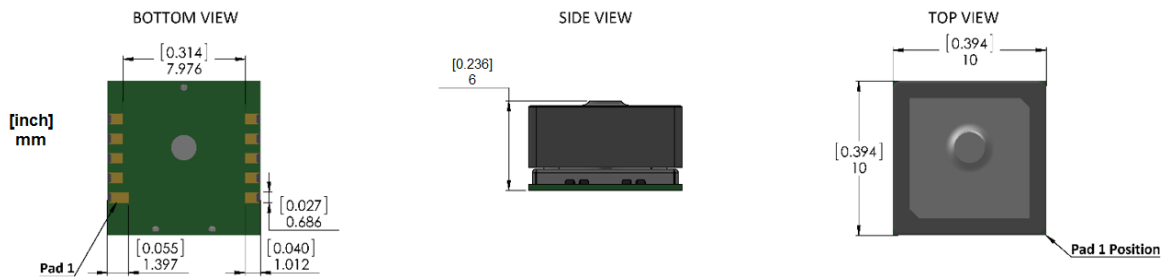


FIGURE 7 – MECHANICAL DRAWING

Dimensions	Length		Width		Height		Weight	
	mm	1				6.1 +0.20/ -0.05	g	2.4
inch	0.394 +0.004/ -0.002		0.394 +0.004/ -0.002		0.24 +0.008/ -0.002	oz	0.08	

TABLE 4 – MECHANICAL SUMMARY



14. ELECTRICAL SPECIFICATIONS

14.1. ABSOLUTE MAXIMUM RATINGS

Stresses exceeding Absolute Maximum Ratings may damage the device.

PARAMETER	SYMBOL	MIN	MAX	UNIT
Power Supply Voltage	V_{CC}	-0.30	+4.3	V
Power Supply Current ¹	I_{CC}		100	mA
RF Input Voltage ²	V_{RF}	-0.30	+3.6	V
I/O Voltage	V_{IO}	-0.30	+3.6	V
I/O Source/Sink Current	I_{IO}		+8	mA
ESD Voltage	$V_{IO/RF, HBM Model}^3$	(-/+) 1000	(-/+) 3000	V
	$V_{IO/RF, MM Model}^4$	(-/+) 100	(-/+) 300	V
RF Power ⁵	$f_{IN} = 1560MHz \div 1630MHz$		+10	dBm
	$f_{IN} < 1560MHz, > 1630MHz$		+30	dBm
Operating Temperature	T_{AMB}	-45	+90	°C
Storage Temperature	T_{ST}	-50	+125	°C
Lead Temperature ⁶	T_{LEAD}	-5	+260	°C

TABLE 5 – ABSOLUTE MAXIMUM RATINGS

Notes:

1. Inrush current of up to 100mA for about 20µs duration.
2. Voltage applied on antenna element.
3. Human Body Model (HBM) contact discharge per EIA/JEDEC JESD22-A114D. Step: 500V (+/-).
4. Machine Model (MM) contact discharge per EIA/JEDEC JESD22-A115C. Step: 50V (+/-).
5. Power delivered to antenna element.
6. Lead temperature at 1mm from case for 10s duration.

14.2. RECOMMENDED OPERATING CONDITIONS

Exposure to stresses above Recommended Operating Conditions may affect device reliability.

PARAMETER	SYMBOL	MODE / PAD	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Power supply voltage	V _{CC}	V _{CC}		+3	+3.3	+3.6	V	
Backup battery voltage	V _{BCKP}			+2	+3	+3.6	V	
Backup battery current	I _{BCKP}		V _{BCKP} =3V, V _{CC} =0		10		uA	
Input pin voltage range	V _{in}			-0.3		+3.6	V	
Digital IO Pin Low level input voltage	V _{il}			-0.3		+0.7	v	
Digital IO Pin High level input voltage	V _{ih}			+2.1		+3.6	V	
Digital IO Pin Low level output voltage	V _{ol}		I _{ol} =2mA	-0.3		+0.4	v	
Digital IO Pin High level output voltage	V _{oh}		I _{oh} =2mA	+2.4	+2.8	+3.1	v	
Power Supply Current ¹	I _{CC}	Acquisition	GPS		24	32	mA	
			GPS+GLONASS		32		mA	
		Tracking	GPS		24		mA	
			GPS+GLONASS		24		mA	
		Standby					0.5	mA
		backup				15		μA
Input Impedance	Z _{IN}	RF Input	f _{IN} = 1575.5MHz		50		Ω	
Input Return Loss	R _{LIN}			-7			dB	
Input Power Range	P _{IN}		GPS or GLONASS	-165		-110	dBm	
Input Frequency Range	f _{IN}			1560		1620	MHz	
Operating Temperature	T _{AMB}			-40	+25	+85	°C	
Storage Temperature ²	T _{ST}			-50	+25	+125	°C	
Relative Humidity ³	R _H		T _{AMB}	5		95	%	

TABLE 6 – RECOMMENDED OPERATING CONDITIONS

Notes:

1. Typical values under conducted signal conditions of -130dBm and ambient temperature of +25°C and low gain configuration.
2. Longer TTFF is expected while operating below -30°C to -40°C.
3. Relative Humidity is within Operating Temperature range.



15. PERFORMANCE

15.1. ACQUISITION TIME

TTFF (Time To First Fix) – is the period of time from module’s power-up till valid position estimation.

15.1.1. HOT START

Hot Start results either from a software reset after a period of continuous navigation or a return from a short idle period that was preceded by a period of continuous navigation. During Hot Start all critical data (position, velocity, time, and satellite ephemeris) is valid to the specified accuracy and available in RAM.

15.1.2. SIGNAL REACQUISITION

Reacquisition follows temporary blocking of GNSS signals. Typical reacquisition scenario includes driving through tunnel.

15.1.3. AIDED START

Aided Start is a method of effectively reducing TTFF by providing valid satellite ephemeris data. Aiding can be implemented using Embedded Assist System (EASY) and Extended Prediction Orbit (EPO) and HotStill

15.1.4. WARM START

Warm Start typically results from user-supplied position and time initialization data or continuous RTC operation with an accurate last known position available in RAM. In this state position and time data are present and valid, but satellite ephemeris data validity has expired.

15.1.5. COLD START

Cold Start occurs when satellite ephemeris data, position and time data are unknown. Typical Cold Start scenario includes first power application.

OPERATION ¹	MODE	VALUE	UNIT
Hot Start		< 1	s
Aided Start ³		< 3	s
Warm Start	GPS + GLONASS	< 26	s
	GPS	< 29	s
Cold Start	GPS + GLONASS	< 23	s
	GPS	< 31	s
Signal Reacquisition ²		< 3	s

TABLE 7 – ACQUISITION TIME

Notes:

1. EVK is 24-hrs. static under signal conditions of -130dBm and ambient temperature of +25°C.
2. Outage duration ≤ 30s.
3. Dependent on aiding data connection speed and latency

15.2. SENSITIVITY

15.2.1. TRACKING

Tracking is an ability of receiver to maintain valid satellite ephemeris data. During tracking receiver may stop output valid position solutions. Tracking sensitivity defined as minimum GNSS signal power required for tracking.

15.2.2. REACQUISITION

Reacquisition follows temporary blocking of GNSS signals. Reacquisition sensitivity defined as minimum GNSS signal power required for reacquisition.

15.2.3. NAVIGATION

During navigation receiver consequently outputs valid position solutions. Navigation sensitivity defined as minimum GNSS signal power required for reliable navigation.

15.2.4. HOT START

Hot Start sensitivity defined as minimum GNSS signal power required for valid position solution under Hot Start conditions.

15.2.5. AIDED START

Aided Start sensitivity defined as minimum GNSS signal power required for valid position solution following aiding process.

15.2.6. COLD START

Cold Start sensitivity defined as minimum GNSS signal power required for valid position solution under Cold Start conditions, sometimes referred as ephemeris decode threshold.

OPERATION ¹	MODE	VALUE	UNIT
Tracking	GPS	-165	dBm
	GLONASS	-165	dBm
Navigation	GPS	-163	dBm
	GLONASS	-163	dBm
Reacquisition ²	GPS+GLONASS	-160	dBm
Hot Start	GPS+GLONASS	-163	dBm
Aided Start	GPS+GLONASS	-160	dBm
Cold Start	GPS+GLONASS	-148	dBm

TABLE 8 – SENSITIVITY

15.3. RECEIVED SIGNAL STRENGTH

PARAMETER ⁴	VALUE	UNIT
C/N ₀	45	dB-Hz

TABLE 9 – RECEIVED SIGNAL STRENGTH

Notes:

1. EVK is static, ambient temperature is +25°C, RF signals are conducted
2. Outage duration ≤ 30s.
3. Aiding using Broadcast Ephemeris (Ephemeris Push™) or Extended Ephemeris (CGEE™ or SGEE™).
4. Average C/N₀ reported for 4 SVs, EVK is 24-hrs. static, outdoor, ambient temperature is +25°C.

15.4. POWER CONSUMPTION

OPERATION ¹	MODE	VALUE	UNIT
Acquisition	GPS	78.5	mW
	GPS + GLONASS	105	mW
Tracking	GPS	104	mW
	GPS + GLONASS	79	mW
Periodic: Low Power Tracking	15 sec asleep 3 sec awake	14.5	mW
Standby state		1.65	mW
Backup state		49.5	uW

TABLE 10 – POWER CONSUMPTION

Note:

1. Typical values under conducted signal conditions of -130dBm and ambient temperature of +25°C.

15.5. POSITION ACCURACY

Parameter	Constellation	CEP (m)
Horizontal Position Accuracy	GPS	2.5
Horizontal Position Accuracy	Glonass	2.6
Horizontal Position Accuracy	BeiDou	10.2
Horizontal Position Accuracy	GPS + Glonass	2.5
Horizontal Position Accuracy	GPS + BeiDou	2.5

TABLE 11 – ORG1510-MK04 POSITION ACCURACY

Notes:

1. Module is static under signal conditions of -130dBm, ambient temperature is +25°C.
2. EVK is 24-hrs. static, ambient temperature is +25°C.
3. Speed over ground \leq 30m/s.

15.6. DYNAMIC CONSTRAINS

PARAMETER	Metric	Imperial
Velocity and Altitude ¹	515m/s and 18,288m	1,000knots and 60,000ft
Velocity	600m/s	1,166knots
Altitude	-500m to 24,000m	-1,640ft to 78,734ft
Acceleration	4g	
Jerk	5m/s ³	

TABLE 12 – DYNAMIC CONSTRAINS

Note:

1. Standard dynamic constrains according to regulatory limitations.

16. INTERFACE

16.1. POWER SUPPLY

It is recommended to keep the power supply on all the time in order to maintain RTC block active and keep satellite data in RAM for fastest possible TTFF. When V_{CC} is removed settings are reset to factory default and the receiver performs Cold Start on next power up.

16.1.1. Nominal VCC = 3.3V

V_{CC} is 3.3v DC and must be provided from regulated power supply.

During tracking the processing is less intense compared to acquisition, therefore power consumption is lower.

Filtering is important to manage high alternating current flows on the power input connection.

An additional LC filter on ORG1510-MK04 power input may be needed to reduce system noise.

The high rate of ORG1510-MK04 input current change requires low ESR bypass capacitors.

Additional higher ESR output capacitors can provide input stability damping.

The ESR and size of the output capacitors directly define the output ripple voltage with a given inductor size. Large low ESR output capacitors are beneficial for low noise.

16.1.2. GROUND

Ground pad must be connected to host PCB Ground with shortest possible trace or by multiple VIAs.

16.2. CONTROL INTERFACE

16.2.1 UART- HOST INTERFACE

Multi Micro Hornet ORG1510-MK04 has a standard UART ports:

16.2.1.1 TX

TX used for GPS data reports. Output logic high voltage level is 2.8V.

The TX serial data line outputs NMEA serial data at a default bit rate of 9600 bps.

When no serial data is being output the TX data line idles high.

16.2.1.2 RX

RX used for receiver control. Input logic high voltage level is 2.8V.

The RX data line accepts NMEA commands at a default bit rate of 9600 bps.

When the receiver is powered down, do not back drive this or any other GPIO line.

The idle state for serial data from the host computer is logic 1.

16.2.1.3 CTS

On CTS an external pull-up of 10K Ω is needed for continues work of ORG1510-MK04.

While CTS="0" ORG 1510M-MK04 is waiting for Host RTS signal.

16.2.2 DATA INTERFACE

16.2.2.1 FORCE-ON

Force-ON is an input signal that can be used to wake up the SE868-A from the sleep mode. It is internally pulled-up. It has active-low logic, i.e. the module wakes up when FORCE_ON is tied to ground. When inactive, it should be left open drain or open collector.

Note:

Keeping FORCE_ON tied to ground will not prevent the SE868-A from going into sleep mode, since this signal is sensitive only to the high-low transition.

No pull-up circuits are allowed on the FORCE_ON pin, since the signal is already internally pulled up.

16.2.2.2 RESET

In addition, external reset is available through $\overline{\text{RESET}}$ pad.
Active low signal. Signal logic level of 2.8V.

16.2.2.3 1PPS

Pulse-Per-Second (PPS) output provides a pulse signal for timing purposes.
The pulse is configurable for required duration, frequency and active high/low via command.
The pulse may vary 30 nS (1σ). The relationship between the PPS signal and UTC is unspecified.
Use Proprietary Mediatek command PMTK255 to enable or disable this functionality:

- **PMTK255,1 => enable PPS**
- **PMTK255,0 => disable PPS**

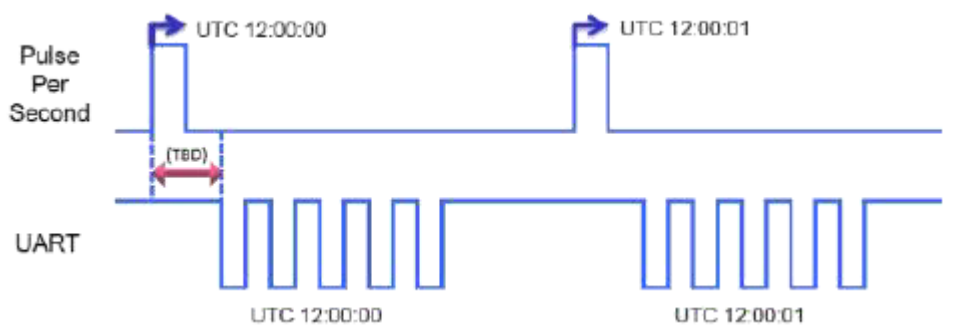


FIGURE 8 – 1PPS AND UTC

1PPS supports 1Hz NMEA output, but at baud rate of 9600 bps, if there are many NMEA sentences output, per second transmission may exceed one second.

17. TYPICAL APPLICATION CIRCUIT

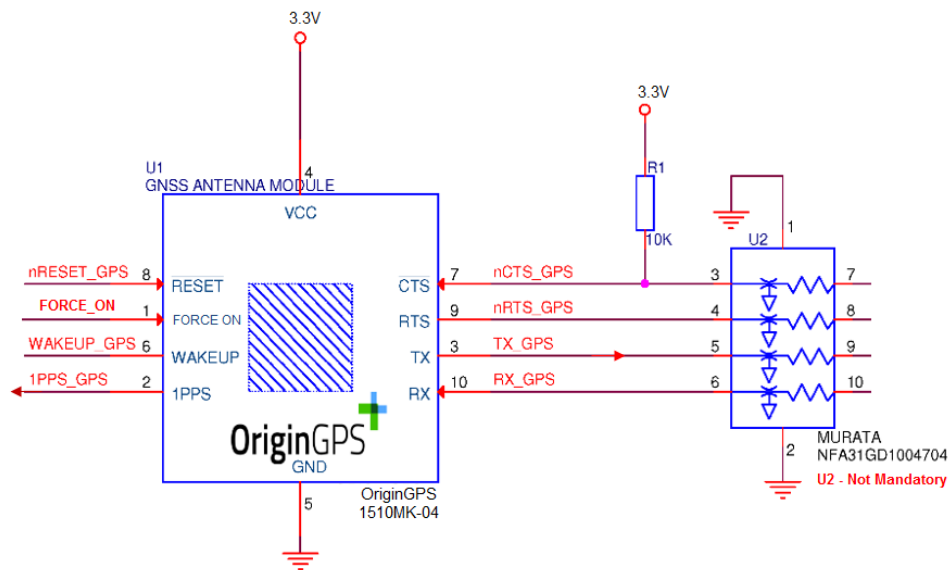


FIGURE 9 – REFERENCE SCHEMATIC DIAGRAM

18. RECOMMENDED PCB LAYOUT

18.1. FOOTPRINT

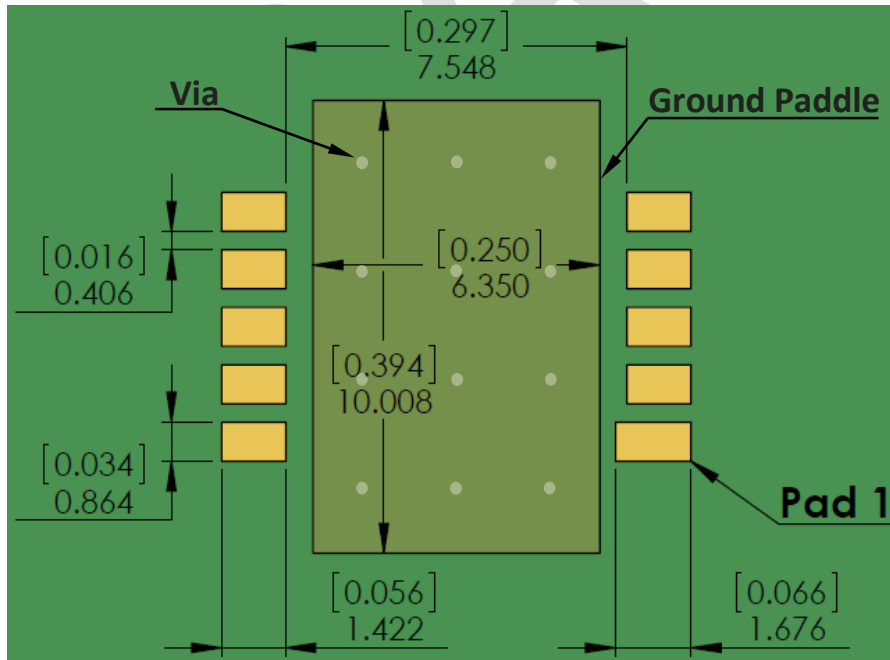


FIGURE 10 – FOOTPRINT

Ground paddle at the middle should be connected to main Ground plane by multiple VIAs.

Ground paddle at the middle must be solder masked.

Silk print of module's outline is highly recommended for SMT visual inspection.

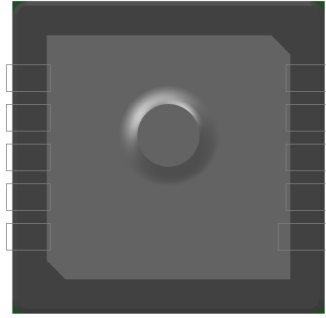


FIGURE 11 – MODULE HOSTED ON FOOTPRINT

18.2. HOST PCB

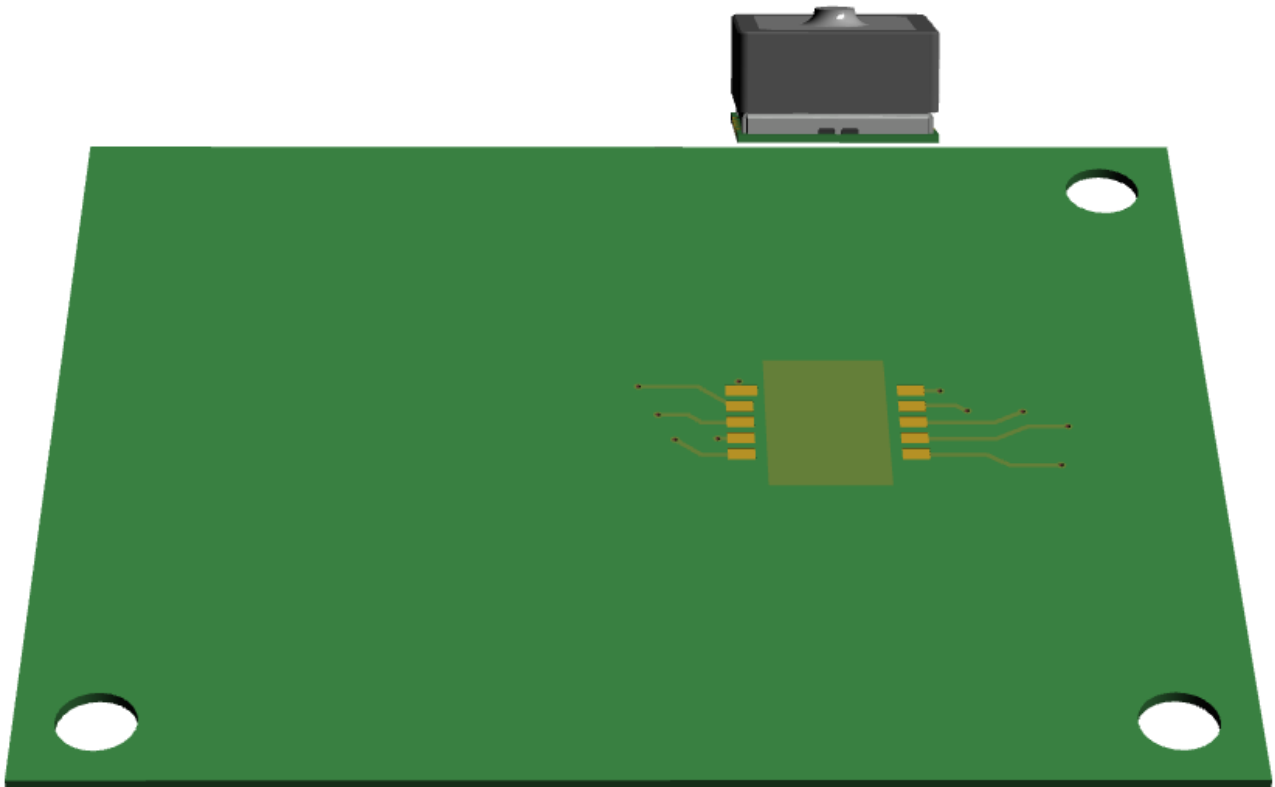


FIGURE 12 – HOST PCB



FIGURE 13– EVB GROUND PLANE VIAS (TOP)

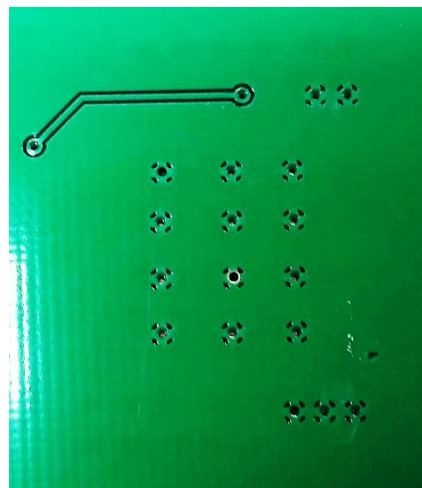


FIGURE 14 – EVB GROUND PLANE VIAS (BOTTOM)

18.3. PCB STACK-UP

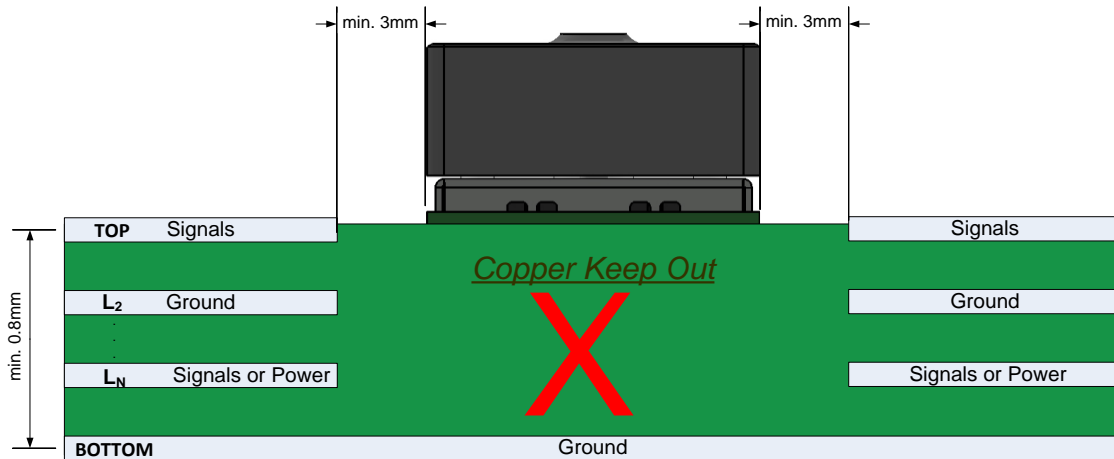


FIGURE 15 – TYPICAL PCB STACK-UP

18.4. PCB LAYOUT RESTRICTIONS

Switching and high-speed components, traces and VIAs must be kept away from ORG1510 module. Signal traces to/from module should have minimum length.

Recommended minimal distance from adjacent active components is 3mm.

Ground pads must be connected to host PCB Ground with shortest possible traces or VIAs.

In case of tight integration constrain or co-location with adjacent high speed components like CPU or memory, high frequency components like transmitters, clock resonators or oscillators, LCD panels or CMOS image sensors, contact OriginGPS for application specific recommendations.

19. DESIGN CONSIDERATIONS

ORG1510 incorporates on-board antenna element that is perfectly matched to receiver front-end, frequency trimmed to GPS band and Right-Hand Circularly Polarized (RHCP).

OriginGPS proprietary module structure is providing stable resonance of antenna in GPS band with very low dependence on host PCB size, it's conducting planes geometry and stack-up.

To prevent PCB factor on antenna resonance avoid copper pouring on module side.

To prevent module orientation from causing polarization losses in on-board antenna avoid long and narrow copper planes beneath.

ORG1510 operates with received signal levels down to -167dBm and can be affected by high absolute levels of RF signals out of GNSS band, moderate levels of RF interference near GNSS band and by low-levels of RF noise in GNSS band.

RF interference from nearby electronic circuits or radio transmitters can contain enough energy to desensitize ORG1510. These systems may also produce levels of energy outside of GNSS band, high enough to leak through RF filters and degrade the operation of the radios in ORG1510.

This issue becomes more critical in small products, where there are industrial design constraints.

In that environment, transmitters for Wi-Fi, Bluetooth, RFID, cellular and other radios may have antennas physically close to ORG1510.

To prevent degraded performance of ORG1510, OriginGPS recommends performing EMI/jamming susceptibility tests for radiated and conducted noise on prototypes and assessing risks of other factors.

Contact OriginGPS for application specific recommendations and design review services.



20. COMMANDS DESCRIPTION

Command ID	Description
PMTK000	Test. This command will be echoed back to the sender (for testing the communications link).
PMTK101	Perform a HOT start
PMTK102	Perform a WARM start
PMTK103	Perform a COLD start
PMTK104	Perform a system reset (erasing any stored almanac data) and then a COLD start
PMTK120	Erase aiding data stored in flash memory
PMTK127	Erase EPO data stored in flash memory
PMTK161,0	Standby - Stop mode
PMTK161,1	Standby - Sleep mode
PMTK251,Baudrate	Set NMEA Baudrate
PMTK313,0	Disable SBAS feature
PMTK313,1	Enable SBAS feature
PMTK353,1,0,0,0,0	Enable GPS only mode
PMTK353,0,1,0,0,0	Enable GLO only mode
PMTK353,0,0,0,0,1	Enable BDS only mode
PMTK353,1,1,0,0,0	Enable GPS and GLO mode
PMTK353,1,0,0,0,1	Enable GPS and BDS mode

TABLE 13– NMEA INPUT COMMANDS

21. FIRMWARE UPDATES

The FW stored in the internal Flash memory may be upgraded via the serial port TX/RX pads. In order to update the FW, the following steps should be performed to perform reprogramming:

1. Remove all power to the module.
2. Connect serial port to a PC.
3. Apply main power.
4. Run the software utility to re-flash the module. Clearing the entire flash memory is strongly recommended prior to programming.
5. Upon successful completion of re-flashing, remove main power to the module for a minimum of 10 seconds.
6. Apply main power to the module.
7. Verify the module has returned to the normal operating state.

22. HANDLING INFORMATION

22.1. MOISTURE SENSITIVITY

ORG1510 modules are MSL 3 designated devices according to IPC/JEDEC J-STD-033B standard. Module in sample or bulk package should be baked prior to assembly at 125°C for 48 hours.

22.2. ASSEMBLY

The module supports automatic pick-and-place assembly and reflow soldering processes. Suggested solder paste stencil is 5 mil to ensure sufficient solder volume.

22.3. SOLDERING

Reflow soldering of the module always on component side (Top side) of the host PCB according to standard IPC/JEDEC J-STD-020D for LGA SMD.

Avoid exposure of ORG1510 to face-down reflow soldering process.

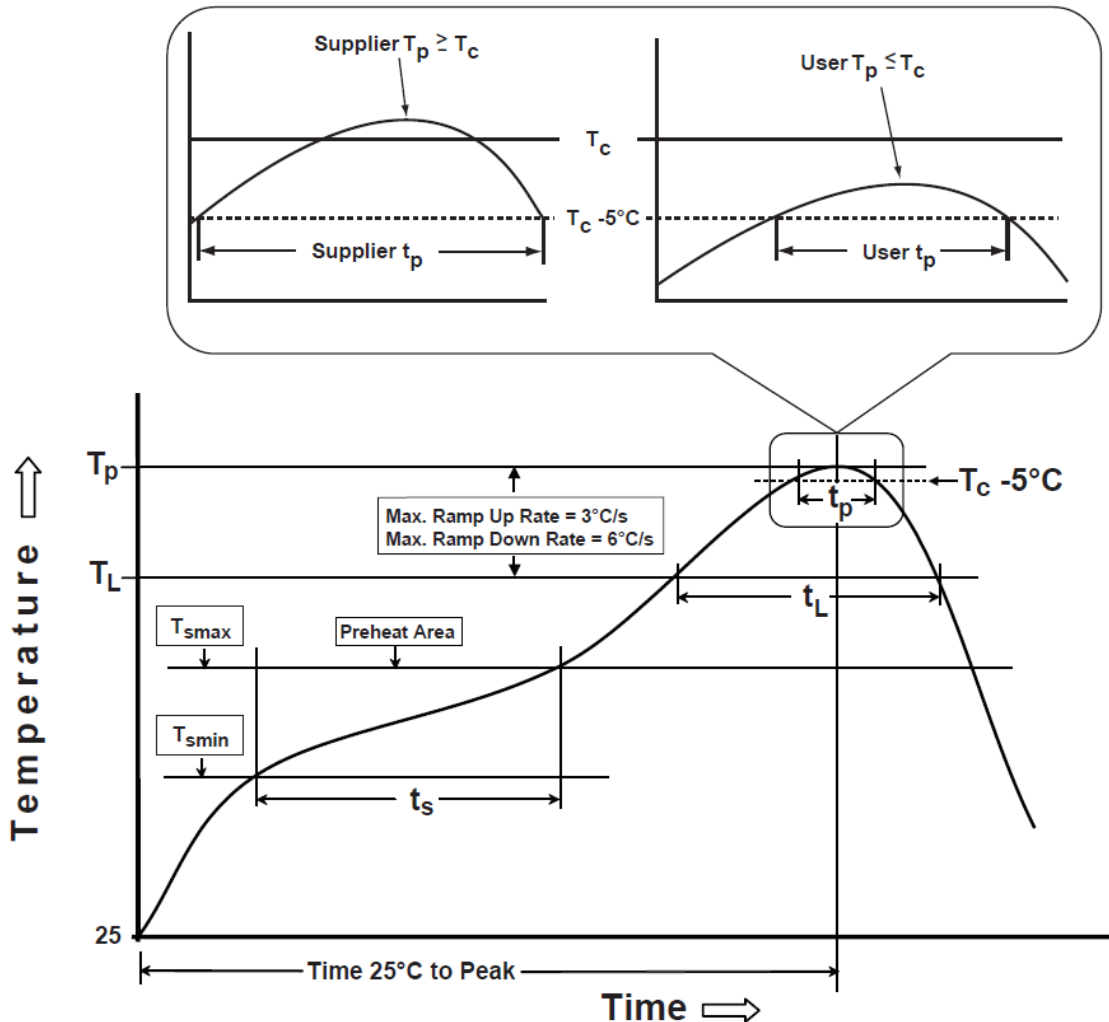


FIGURE 16 – RECOMMENDED SOLDERING PROFILE

Referred temperature is measured on top surface of the package during the entire soldering process. Suggested peak reflow temperature is 245°C for 30 sec. for Pb-Free solder paste.

Actual board assembly reflow profile must be developed individually per furnace characteristics. Reflow furnace settings depend on the number of heating/cooling zones, type of solder paste/flux used, board design, component density and packages used.

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
T _c	Classification Temperature		245		°C
T _p	Package Temperature			245	°C
T _L	Liquidous Temperature		217		°C
T _s	Soak/Preheat Temperature	150		200	°C
t _s	Soak/Preheat Time	60		120	s
t _L	Liquidous Time	60		150	s
t _p	Peak Time		30		s

TABLE 14 – SOLDERING PROFILE PARAMETERS

22.4. CLEANING

If flux cleaning is required, module is capable to withstand standard cleaning process in vapor degreaser with the Solvon® n-Propyl Bromide (NPB) solvent and/or washing in DI water.

Avoid cleaning process in ultrasonic degreaser, since specific vibrations may cause performance degradation or destruction of internal circuitry.

22.5. REWORK

If localized heating is required to rework or repair the module, precautionary methods are required to avoid exposure to solder reflow temperatures that can result in permanent damage to the device.

22.6. ESD SENSITIVITY

This product is ESD sensitive device and must be handled with care.



22.7. SAFETY INFORMATION

Improper handling and use can cause permanent damage to the product.

22.8. DISPOSAL INFORMATION

This product must not be treated as household waste.

For more detailed information about recycling electronic components contact your local waste management authority.



23. COMPLIANCE

The following standards are applied on the production of ORG1510 modules:

- + IPC-6011/6012 Class2 for PCB manufacturing
- + IPC-A-600 Class2 for PCB inspection
- + IPC-A-610D Class2 for SMT acceptability

ORG1510 modules are manufactured in ISO 9001:2008 accredited facilities.

ORG1510 modules are manufactured in ISO 14001:2004 accredited facilities.

ORG1510 modules are manufactured in OHSAS 18001:2007 accredited facilities.

ORG1510 modules are designed, manufactured and handled in compliance with the Directive 2011/65/EU of the European Parliament and of the Council of June 2011 on the Restriction of the use of certain Hazardous Substances in electrical and electronic equipment, referred as RoHS II.

ORG1510 modules are manufactured and handled in compliance with the applicable substance bans as of Annex XVII of Regulation 1907/2006/EC on Registration, Evaluation, Authorization and Restriction of Chemicals including all amendments and candidate list issued by ECHA, referred as REACH.

ORG1510 modules comply with the following EMC standards:

- + EU CE EN55022:06+A1(07), Class B
- + US FCC 47CFR Part 15:09, Subpart B, Class B
- + JAPAN VCCI V-3/2006.04



24. PACKAGING AND DELIVERY

24.1. APPEARANCE

ORG1510 modules are delivered in reeled tapes for automatic pick and place assembly process.

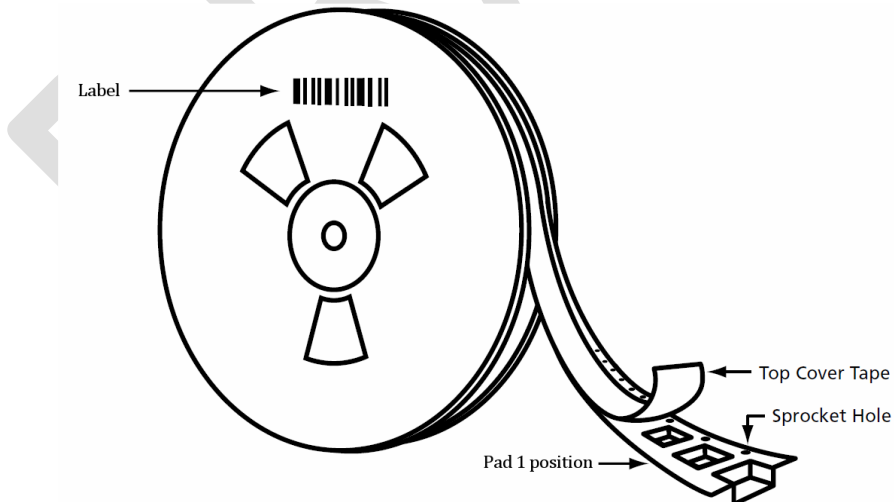


FIGURE 17 – MODULE POSITION

ORG1510 modules are packed in 2 different reel types.

SUFFIX	TR1	TR2
Quantity	150	500

TABLE 15 – REEL QUANTITY

Reels are dry packed with humidity indicator card and desiccant bag according to IPC/JEDEC J-STD-033B standard for MSL 3 devices.

Reels are vacuum sealed inside anti-static moisture barrier bags.

Sealed reels are labeled with MSD sticker providing information about:

- + MSL
- + Shelf life
- + Reflow soldering peak temperature
- + Seal date

Sealed reels are packed inside cartons.

Reels, reel packs and cartons are labeled with sticker providing information about:

- + Description
- + Part number
- + Lot number
- + Customer PO number
- + Quantity
- + Date code

24.2. CARRIER TAPE

Carrier tape material - polystyrene with carbon (PS+C).

Cover tape material – polyester based film with heat activated adhesive coating layer.

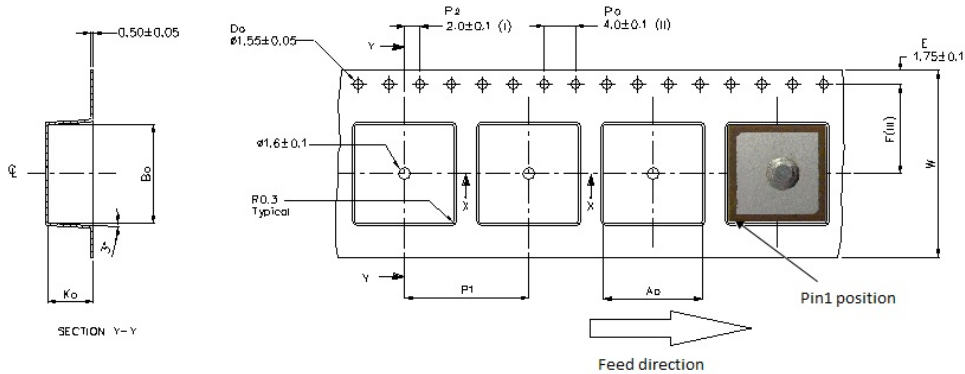


FIGURE 18 – CARRIER TAPE

	mm	inch
A ₀	10.9 ± 0.1	0.429 ± 0.004
B ₀	10.7 ± 0.1	0.421 ± 0.004
K ₀	6.1 ± 0.1	0.240 ± 0.004
F	7.5 ± 0.1	0.295 ± 0.004
P1	12.0 ± 0.1	0.472 ± 0.004
W	16.0 ± 0.3	0.630 ± 0.012

TABLE 16 – CARRIER TAPE DIMENSIONS

24.3. REEL

Reel material - antistatic plastic.

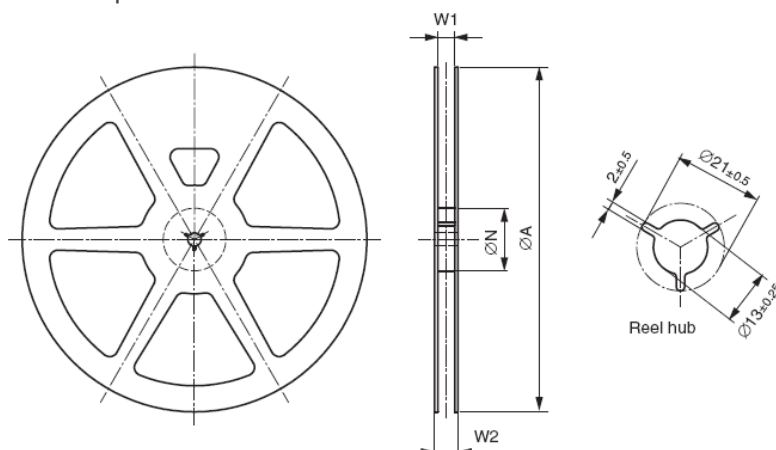


FIGURE 19 – REEL

SUFFIX	TR1		TR2	
	mm	inch	mm	inch
ØA	178.0 ± 1.0	7.00 ± 0.04	330.0 ± 2.0	13.00 ± 0.08
ØN	60.0 ± 1.0	2.36 ± 0.04	102.0 ± 2.0	4.02 ± 0.08
W1	16.7 ± 0.5	0.66 ± 0.02	16.7 ± 0.5	0.66 ± 0.02
W2	19.8 ± 0.5	0.78 ± 0.02	22.2 ± 0.5	0.87 ± 0.02

TABLE 17 – REEL DIMENSIONS

25. ORDERING INFORMATION

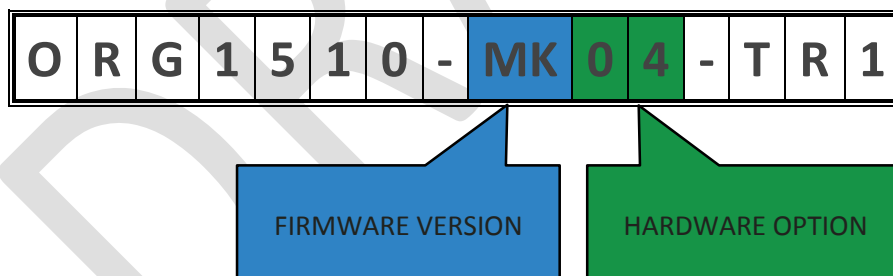


FIGURE 20 – ORDERING OPTIONS

PART NUMBER	FW VERSION	HW OPTION	V _{CC} RANGE	PACKAGING	SPQ
ORG1510MK-04-TR1	1	01	3.3V	REELED TAPE	150
ORG1510 MK-04-TR2	1	01	3.3V	REELED TAPE	500
ORG1510 MK-04-UAR	1	01	5V USB	EVALUATION KIT	1

TABLE 13 – ORDERABLE DEVICES